

2SJ360-VB Datasheet

P-Channel 60-V (D-S) MOSFET

PRODUCT SUMMARY

| V_{DS} (V) | $R_{DS(on)}$ (Ω) | I_D (A) ^a | Q_g (Typ.) |
|--------------|-----------------------------|------------------------|--------------|
| - 60 | 0.058 at $V_{GS} = - 10$ V | - 6.5 | 30 nC |
| | 0.065 at $V_{GS} = - 4.5$ V | - 5.5 | |

FEATURES

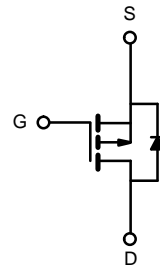
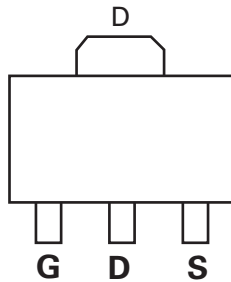
- TrenchFET[®] Power MOSFET
- 100 % UIS Tested

APPLICATIONS

- Load Switch



RoHS
COMPLIANT
HALOGEN
FREE



P-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS ($T_A = 25$ °C, unless otherwise noted)

| Parameter | | Symbol | Limit | Unit |
|--|---------------|----------------|--------------------|------|
| Drain-Source Voltage | | V_{DS} | - 60 | V |
| Gate-Source Voltage | | V_{GS} | ± 20 | |
| Continuous Drain Current ($T_J = 150$ °C) | $T_C = 25$ °C | I_D | - 6.5 ^a | A |
| | $T_C = 70$ °C | | - 5.2 | |
| | $T_A = 25$ °C | | - 4.8 ^b | |
| | $T_A = 70$ °C | | - 4.1 ^b | |
| Pulsed Drain Current | | I_{DM} | - 20 | |
| Avalanche Current Pulse | | I_{AS} | - 4.5 | mJ |
| Single Pulse Avalanche Energy | | E_{AS} | 10.1 | |
| Continuous Source-Drain Diode Current | $T_C = 25$ °C | I_S | 6.9 ^a | A |
| | $T_A = 25$ °C | | 3.5 ^b | |
| Maximum Power Dissipation | $T_C = 25$ °C | P_D | 10.4 ^a | W |
| | $T_C = 70$ °C | | 6.6 ^a | |
| | $T_A = 25$ °C | | 2.1 ^b | |
| | $T_A = 70$ °C | | 1.1 ^b | |
| Operating Junction and Storage Temperature Range | | T_J, T_{stg} | - 55 to 150 | °C |

THERMAL RESISTANCE RATINGS

| Parameter | | Symbol | Typical | Maximum | Unit |
|--|--------------|------------|---------|---------|------|
| Maximum Junction-to-Ambient ^b | Steady State | R_{thJA} | 33 | 40 | °C/W |
| | Steady State | R_{thJC} | 0.98 | 1.2 | |

Notes:

a. Based on $T_C = 25$ °C.

b. Surface mounted on 1" x 1" FR4 board.

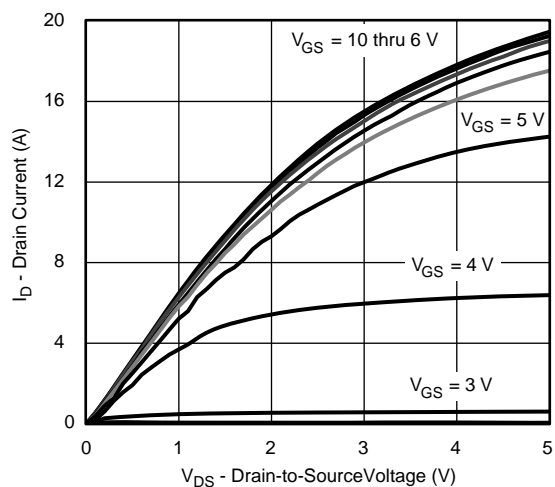
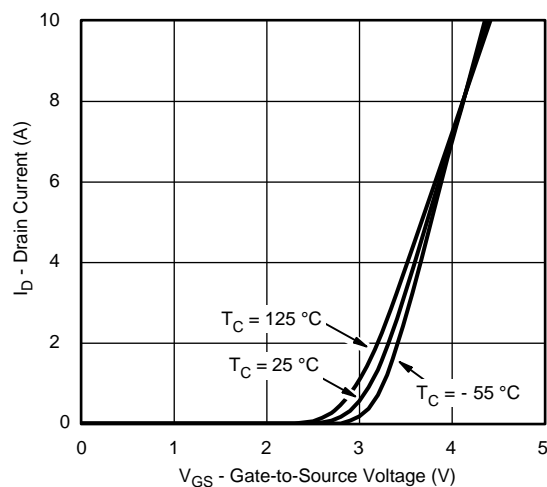
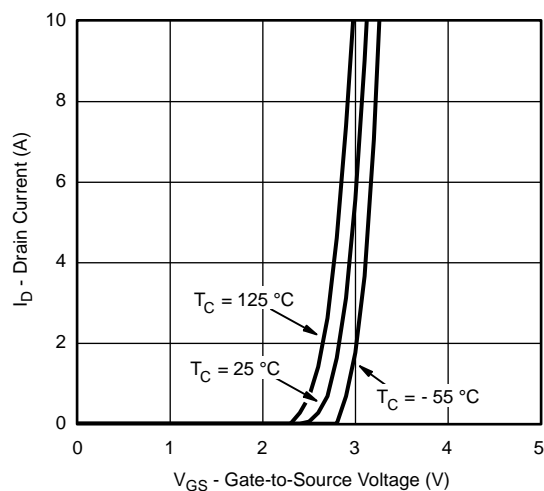
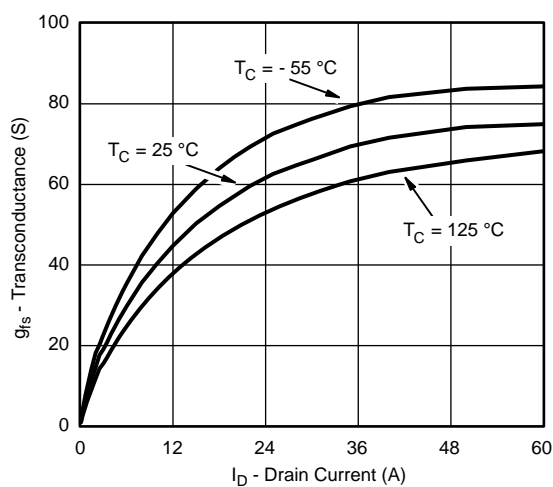
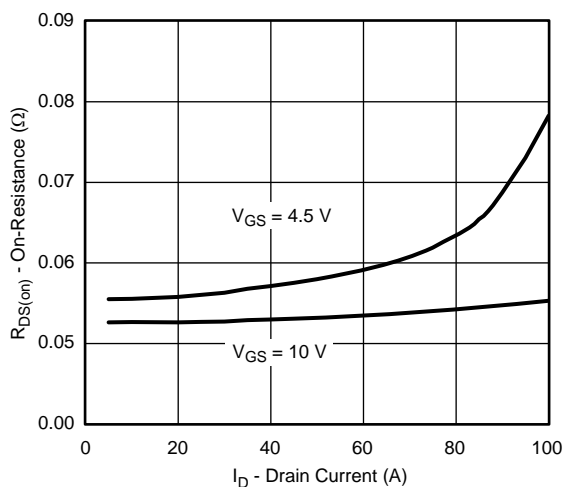
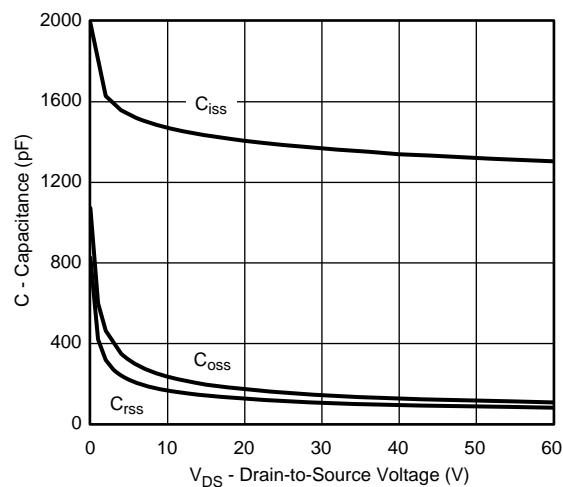
| SPECIFICATIONS (T _J = 25 °C, unless otherwise noted) | | | | | | |
|---|--------------------------------------|--|-------|-------|-------|-------|
| Parameter | Symbol | Test Conditions | Min. | Typ. | Max. | Unit |
| Static | | | | | | |
| Drain-Source Breakdown Voltage | V _{DS} | V _{GS} = 0 V, I _D = - 250 μA | - 60 | | | V |
| V _{DS} Temperature Coefficient | ΔV _{DS} /T _J | I _D = - 250 μA | | 68 | | mV/°C |
| V _{GS(th)} Temperature Coefficient | ΔV _{GS(th)} /T _J | | | - 5.2 | | |
| Gate-Source Threshold Voltage | V _{GS(th)} | V _{DS} = V _{GS} , I _D = - 250 μA | - 1.2 | | - 2.5 | V |
| Gate-Source Leakage | I _{GSS} | V _{DS} = 0 V, V _{GS} = ± 20 V | | | ± 100 | nA |
| Zero Gate Voltage Drain Current | I _{DSS} | V _{DS} = - 60 V, V _{GS} = 0 V | | | - 1 | μA |
| | | V _{DS} = - 60 V, V _{GS} = 0 V, T _J = 55 °C | | | - 10 | |
| On-State Drain Current ^a | I _{D(on)} | V _{DS} = - 5 V, V _{GS} = - 10 V | - 25 | | | A |
| Drain-Source On-State Resistance ^a | R _{DS(on)} | V _{GS} = - 10 V, I _D = - 3 A | | 0.058 | | Ω |
| | | V _{GS} = - 4.5 V, I _D = - 2 A | | 0.065 | | |
| Forward Transconductance ^a | g _{fs} | V _{DS} = - 15 V, I _D = - 5 A | 20 | | | S |
| Dynamic ^b | | | | | | |
| Input Capacitance | C _{iss} | V _{DS} = - 25 V, V _{GS} = 0 V, f = 1 MHz | | 1500 | | pF |
| Output Capacitance | C _{oss} | | | 200 | | |
| Reverse Transfer Capacitance | C _{rss} | | | 150 | | |
| Total Gate Charge | Q _g | V _{DS} = - 30 V, V _{GS} = - 10 V, I _D = - 5 A | | 38 | 56 | nC |
| | | V _{DS} = - 30 V, V _{GS} = - 4.5 V, I _D = - 5 A | | 19 | 30 | |
| Gate-Source Charge | Q _{gs} | | | 9 | | |
| Gate-Drain Charge | Q _{gd} | | | 10 | | |
| Gate Resistance | R _g | f = 1 MHz | | 5.2 | | Ω |
| Turn-On Delay Time | t _{d(on)} | V _{DD} = - 2 V, R _L = 2 Ω I _D ≅ - 5 A, V _{GEN} = - 10 V, R _g = 1 Ω | | 10 | 15 | ns |
| Rise Time | t _r | | | 7 | 15 | |
| Turn-Off Delay Time | t _{d(off)} | | | 70 | 110 | |
| Fall Time | t _f | | | 40 | 60 | |
| Drain-Source Body Diode Characteristics | | | | | | |
| Continuous Source-Drain Diode Current | I _S | T _C = 25 °C | | | - 6.9 | A |
| Pulse Diode Forward Current ^a | I _{SM} | | | | - 15 | |
| Body Diode Voltage | V _{SD} | I _S = - 3 A | | - 1 | - 1.5 | V |
| Body Diode Reverse Recovery Time | t _{rr} | I _F = - 5 A, di/dt = 10 A/μs, T _J = 25 °C | | 45 | 68 | ns |
| Body Diode Reverse Recovery Charge | Q _{rr} | | | 59 | 120 | nC |
| Reverse Recovery Fall Time | t _a | | | 29 | | ns |
| Reverse Recovery Rise Time | t _b | | | 16 | | |

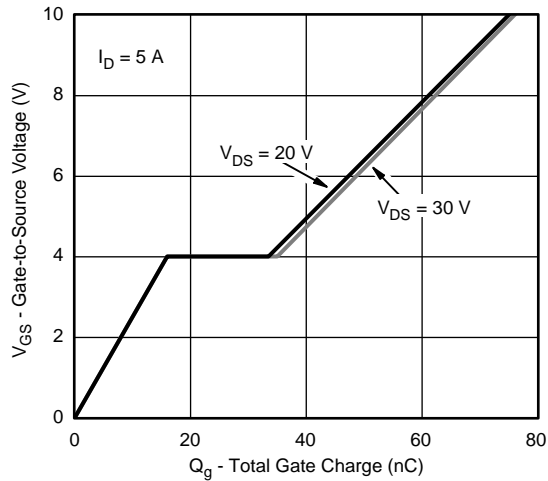
Notes:

a. Pulse test; pulse width $\leq 300\text{ }\mu\text{s}$, duty cycle $\leq 2\%$.

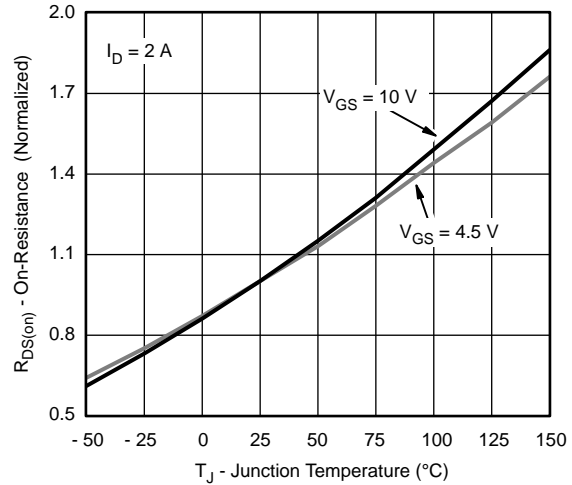
b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

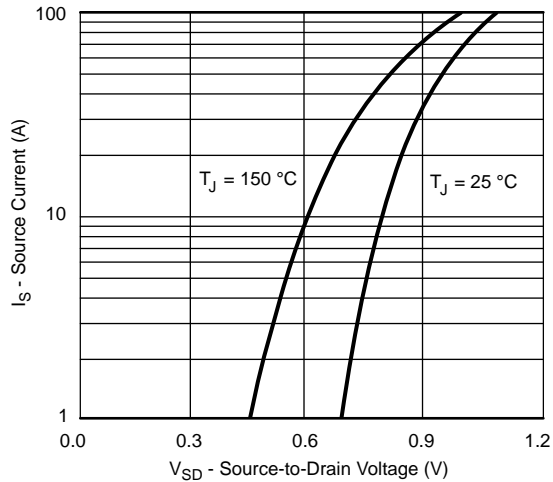
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

Output Characteristics

Transfer Characteristics

Transfer Characteristics

Transconductance

On-Resistance vs. Drain Current

Capacitance

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)


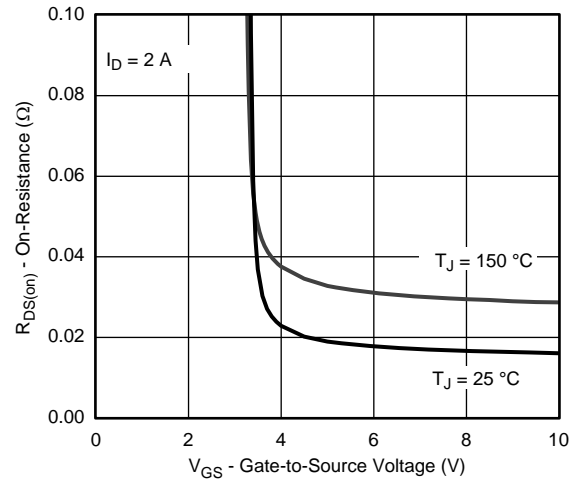
Gate Charge



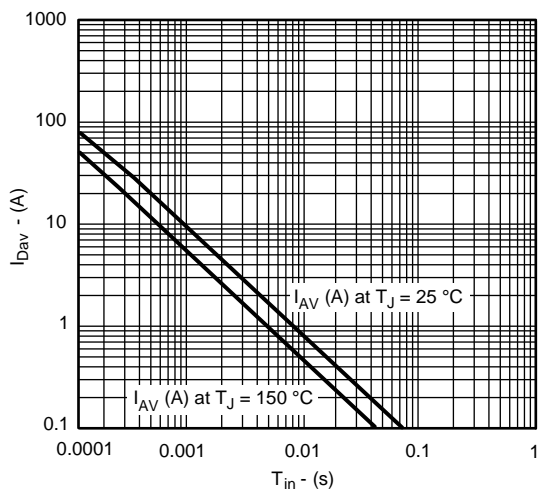
On-Resistance vs. Gate-to-Source Voltage



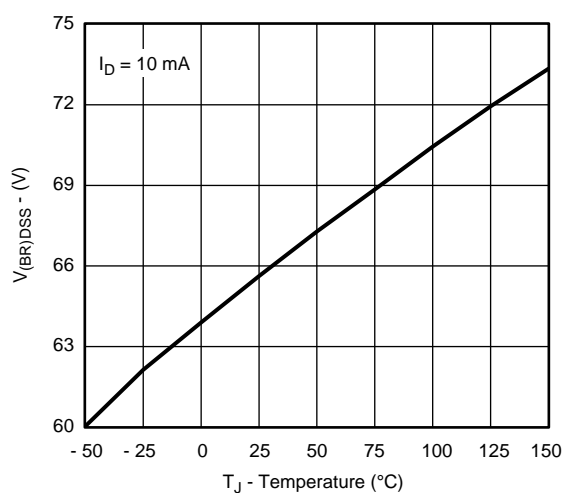
Source-Drain Diode Forward Voltage



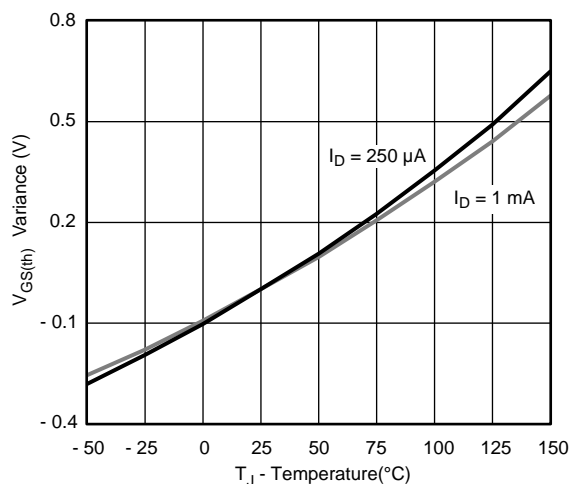
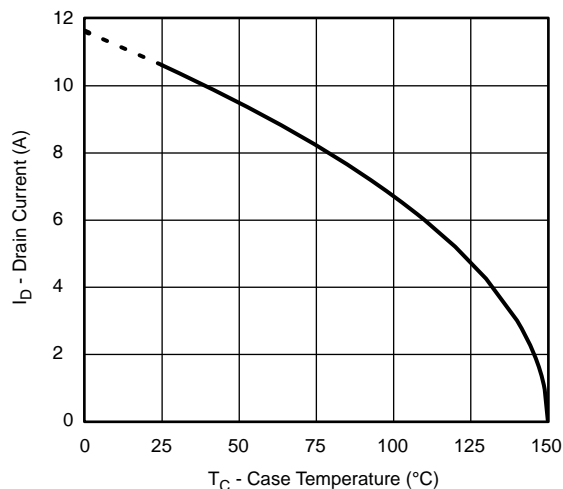
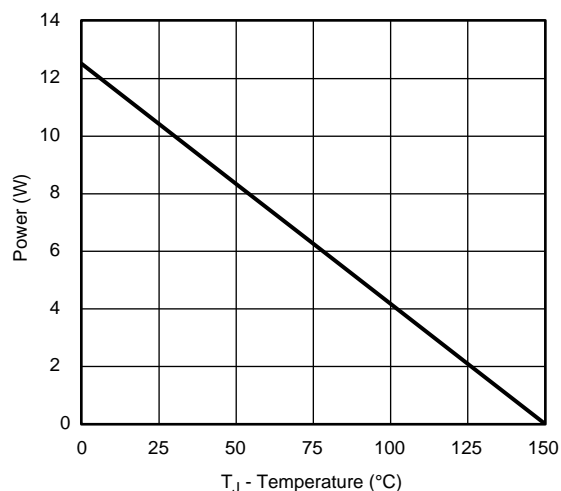
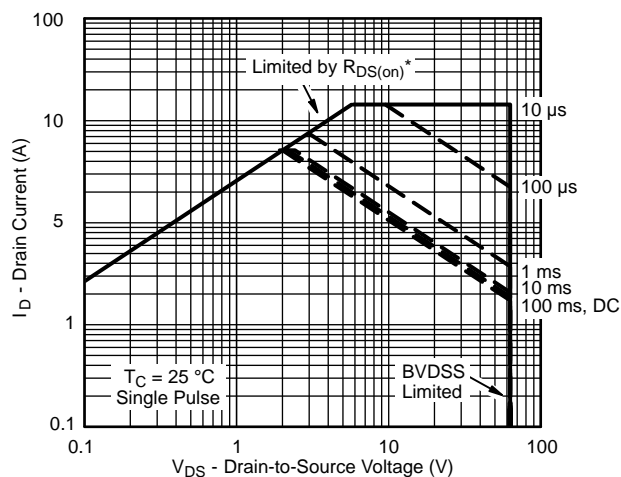
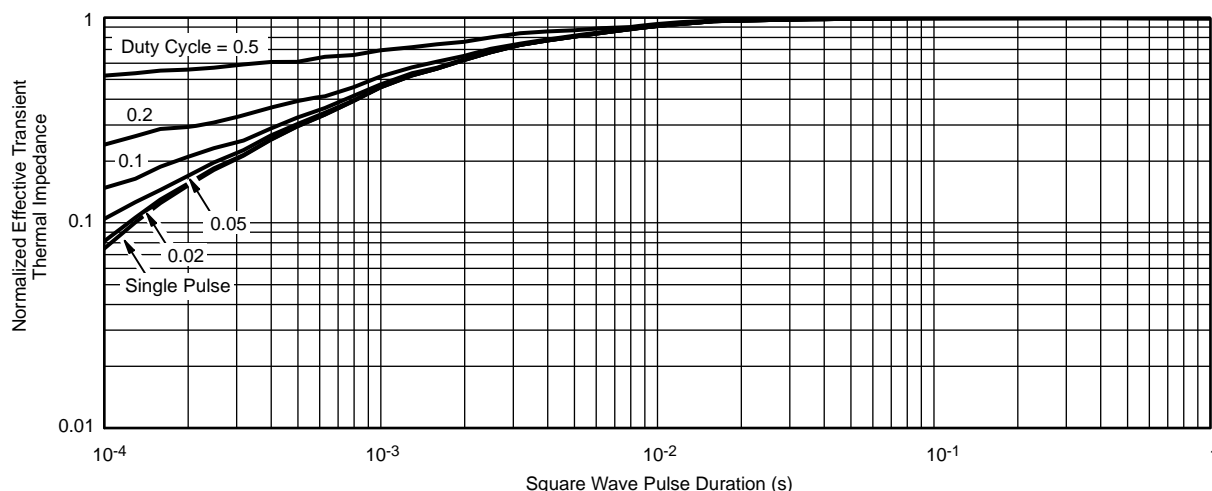
On-Resistance vs. Gate-to-Source Voltage



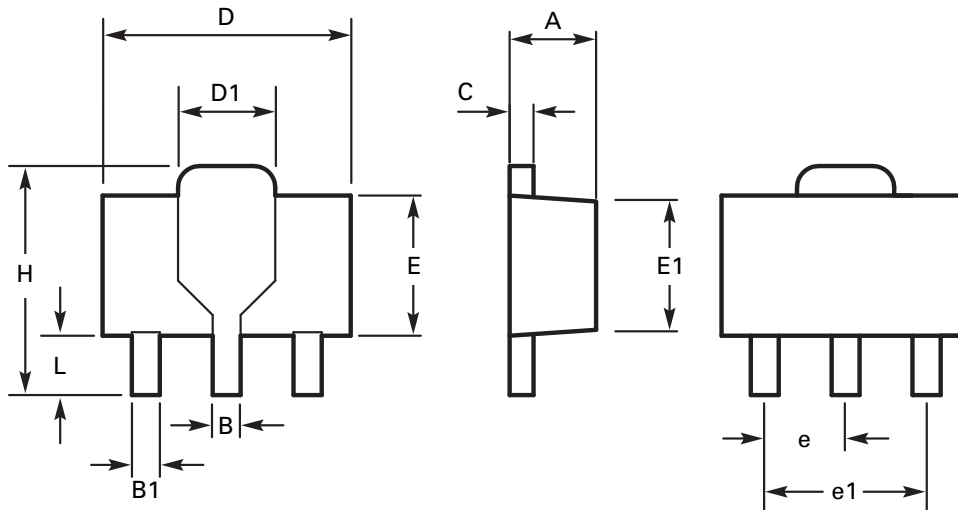
Single Pulse Avalanche Current Capability vs. Time



Drain-Source Breakdown Voltage vs. Junction Temperature

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

Threshold Voltage

Max. Drain Current vs. Case Temperature

Power Derating, Junction-to-Case

Safe Operating Area, Junction-to-Case

Normalized Thermal Transient Impedance, Junction-to-Case

Package outline - SOT89



| DIM | Millimeters | | Inches | | DIM | Millimeters | | Inches | |
|-----|-------------|------|--------|-------|-----|-------------|------|-----------|-------|
| | Min | Max | Min | Max | | Min | Max | Min | Max |
| A | 1.40 | 1.60 | 0.550 | 0.630 | E | 2.29 | 2.60 | 0.090 | 0.102 |
| B | 0.44 | 0.56 | 0.017 | 0.022 | E1 | 2.13 | 2.29 | 0.084 | 0.090 |
| B1 | 0.36 | 0.48 | 0.014 | 0.019 | e | 1.50 BSC | | 0.059 BSC | |
| C | 0.35 | 0.44 | 0.014 | 0.017 | e1 | 3.00 BSC | | 0.118 BSC | |
| D | 4.40 | 4.60 | 0.173 | 0.181 | H | 3.94 | 4.25 | 0.155 | 0.167 |
| D1 | 1.62 | 1.83 | 0.064 | 0.072 | L | 0.89 | 1.20 | 0.035 | 0.047 |

Note: Controlling dimensions are in millimeters. Approximate dimensions are provided in inches

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